

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Raymond CHAN	10/18/2012
Christopher YOUTSEY	10/18/2012
RECEIVING PARTY DATA	
Name:	MicroLink Devices, Inc.
Street Address:	6457 W. Howard Street
City:	Niles
State/Country:	ILLINOIS
Postal Code:	60714
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13649355
CORRESPONDENCE DATA	
Fax Number:	6177424214
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	(617) 202-4624
Email:	ipboston.docketing@nelsonmullins.com
Correspondent Name:	Nelson Mullins Riley & Scarborough LLP
Address Line 1:	One Post Office Square
Address Line 4:	Boston, MASSACHUSETTS 02109-2127
ATTORNEY DOCKET NUMBER:	MLW-017DV1
NAME OF SUBMITTER:	Anthony A. Laurentano
Total Attachments: 2 source=MLW-017DV1 Assignment#page1.tif source=MLW-017DV1 Assignment#page2.tif	

CH \$40.00 13649355

502119799

PATENT
REEL: 029253 FRAME: 0058

ASSIGNMENT BY INVENTORS

WE, **Raymond CHAN**, of Hoffman Estates, Illinois, and **Christopher YOUTSEY**, of Libertyville, Illinois, in consideration of One Dollar and other valuable consideration paid to us by

MicroLink Devices, Inc.

a Corporation of Delaware, having its principal place of business at 6457 W. Howard Street, Niles, Illinois 60714, the receipt of which is hereby acknowledged, do hereby sell, assign and transfer unto said

MicroLink Devices, Inc.

its successors and assigns, the entire interest for the United States of America and all foreign countries including all rights of priority under the International Convention for the Protection of Industrial Property in a certain invention or improvement in

ASSEMBLY TECHNIQUES FOR SOLAR CELL ARRAYS
AND SOLAR CELLS FORMED THEREFROM

described in Application No. 13/649,355, filed on October 11, 2012

This application claims the benefit of Provisional Application No. 61/175,259, filed on May 4, 2009

in the United States Patent and Trademark Office, and in all Letters Patent of the United States and all foreign countries which may or shall be granted on said invention, or any parts thereof, or on said application, or any divisional, continuing, reissue or other applications based in whole or in part thereon. And we agree, for ourselves and our executors and administrators, with said Corporation and its successors and assigns but at its or their expense and charges, hereafter to execute all applications, amended specifications, deed or other instrument, and to do all acts necessary or proper to secure the grant of Letters Patent in the United States and in all other countries to said Corporation, with specifications and claims in such form as shall be approved by the counsel of said Corporation and to vest and confirm in said Corporation, its successors and assigns, the legal title to all such patents.

And we do hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said Corporation, its successors and assigns.

10/18/12
Date

Raymond Chan
Raymond Chan

Witness:

10/18/12
Date

David S McCall

10/18/12
Date

Chris Youtsey
Christopher Youtsey

Witness:

10/18/12
Date

Dan SM'Call